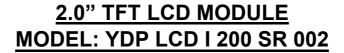
PRODUCT SPECIFICATION





- < >> Preliminary Specification
- < >> Finally Specification

CUSTOMER'S APPROVAL							
CUSTOMER:	CUSTOMER:						
SIG	NATURE:	DATE:					

APPROVED	PM	PD	PREPARED
ВҮ	REVIEWED	REVIEWED	BY
TFT W. Q. H			Funny
20200020			20200020

knitter-switch

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	2023.08.26	ZFY	Initial Release	

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	2.0"	
LCD type	IPS	
Display Mode	Transmissive /Normally black	
Resolution	240 RGB x 320	Pixels
View Direction	FULL VIEW	Best Image
Module Outline	34.6 (H) x 47.8(V) x 2.21(T) (Note1)	mm
Active Area	30.6(H) x40.8(V)	mm
Pixel Size	127.5(H) x127.5(V)	um
Pixel Arrangement	RGB Vertical Stripe	
Polarizer Surface Treatment	Glare	
Display Colors	262K	
Interface	3-SPI +18-bit RGB Interface	
Driver IC	ST7789T3	-
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30∼80	°C
Weight	TBD	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	4.6	V
Storage temperature	T _{STG}	-30	80	°C
Operating temperature	T _{OP}	-20	70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

ltem	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	VCC	2.4	3.0	3.3	V
Logic Low input voltage	V_{IL}	GND	-	0.3*VCC	V
Logic High input voltage	V_{IH}	0.7*VCC	-	VCC	V
Logic Low output voltage	V_{OL}	GND	-	0.2*VCC	V
Logic High output voltage	V _{OH}	0.8*VCC	-	VCC	V
Current Consumption All white	I _{vcc}	-	TBD	-	mA

5. Backlight Characteristic

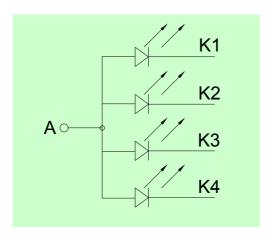
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, I _F =20mA/LED	2.8	3.2	3.4	V
Forward Current	lF	Ta=25 °C, V _F =3.2V/LED	-	80	-	mA
Power dissipation	PD		-	256	-	mW
Uniformity	Avg		-	80	-	%
LED working life(25°C)	-		-	30,000	-	Hrs
Drive method	Constant current					
LED Configuration		4 White LED	s in para	llel		

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25 ±2 °C,60%RH ±5 %, I_F=20mA/LED.

5.2. Backlighting circuit



6. Optical Characteristics

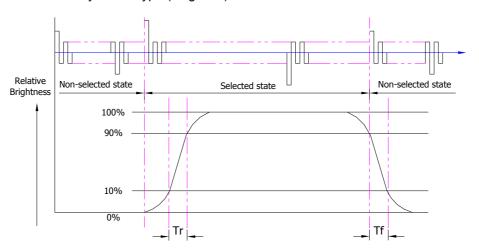
6.1. Optical Characteristics

Ta=25°C, VCC=3.0V

					S	pecificati	on	
	Item		Symbol	Condition	Min.	Typ.	Max.	Unit
	Luminar	nce on						
<u> </u>	$TFT(I_f \texttt{=20mA/LED})$		Lv	Normally	240	300	-	cd/m²
ode	Contrast ratio(See 6.3)		CR	viewing angle	800	1000	-	
Backlight On (Transmissive Mode)	Response time (See 6.2)		TR+TF	$\theta x = \phi Y = 0^{\circ}$	-	30	35	ms
nis		Dod	XR	XR		TBD		
nsr	Chromaticity Transmissive (See 6.5) Red Green Blue	Reu	YR			TBD		
Tra			Xg			TBD		
) u(Yg			TBD		
10		Pluo	Хв			TBD		
ligi		blue	Yв			TBD		
ack		White	Xw			TBD		
m		vvriite	Yw			TBD		
	Vieuvina	Harizantal	θх+		-	85	-	
	_	Viewing Horizontal	θх-	Center CR≥10	-	85	-	Dog
	Angle (See 6.4)	Vortical	φY+	Center CR210	-	85	-	Deg.
	(366 0.4)	ee 6.4) Vertical			-	85	-	
	NTSC Ratio	o(Gamut)			ı	60	-	%

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

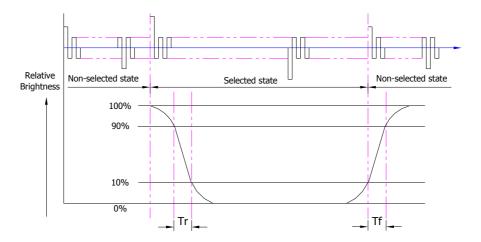


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

6.3. Definition of Contrast Ratio

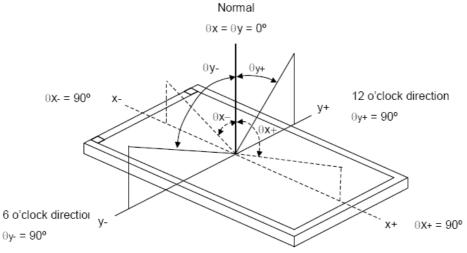
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent		
Measuring Point Diameter	3mm//1mm		
Measuring Point Location	Active Area centre point		
Toot nottorn	A: All Pixels white		
Test pattern	B: All Pixel black		
Contrast setting	Maximum		

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles

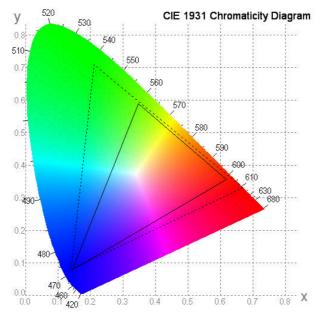


Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

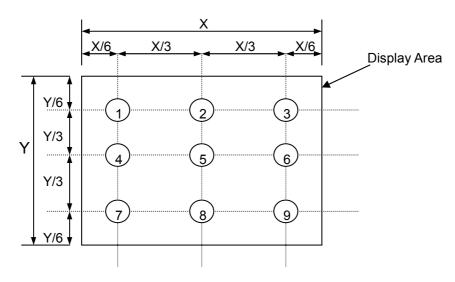


6.6. Definition of Surface Luminance, Uniformity and Transmittance

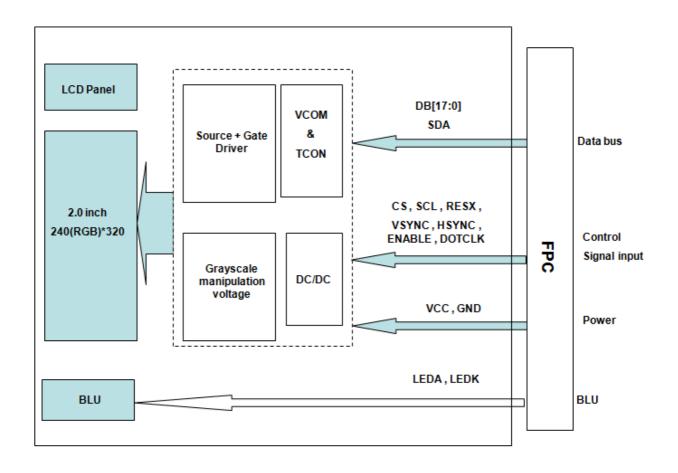
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: L_V = average (L_{P1} : L_{P9})
- 6.6.2. Uniformity = Minimal $(L_{P1}:L_{P9})$ / Maximal $(L_{P1}:L_{P9})$ * 100%
- 6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply

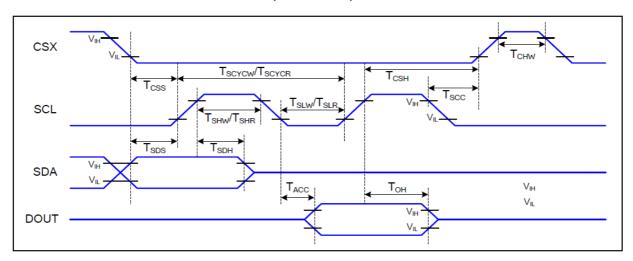


8. Interface Pins Definition

No.	Symbol	Function	Remark
1	LEDK	LED Cathode	
2	LEDA	LED Anode	
3	RESX	Reset signal	
4	cs	Chip select signal	
5	SCL	Serial clock	
6	VSYNC	Vertical (Frame) synchronizing input signal	
7	HSYNC	Horizontal (Line) synchronizing input signal	
8	ENABLE	Data enable signal	
9	GND	Ground	
10	DOTCLK	Dot clock signal for RGB interface operation	
11	GND	Ground	
12	SDA	Serial data input/output pin	
13	DB0	Data Bus	
14	DB1	Data Bus	
15	DB2	Data Bus	
16	DB3	Data Bus	
17	DB4	Data Bus	
18	DB5	Data Bus	
19	DB6	Data Bus	
20	DB7	Data Bus	
21	DB8	Data Bus	
22	DB9	Data Bus	
23	DB10	Data Bus	
24	DB11	Data Bus	
25	DB12	Data Bus	
26	DB13	Data Bus	
27	DB14	Data Bus	
28	DB15	Data Bus	
29	DB16	Data Bus	
30	DB17	Data Bus	
31	VCC	Power Supply	
32	GND	Ground	
33	NC(XR)	No connection	
34	NC(YD)	No connection	
35	NC(XL)	No connection	
36	NC(YU)	No connection	

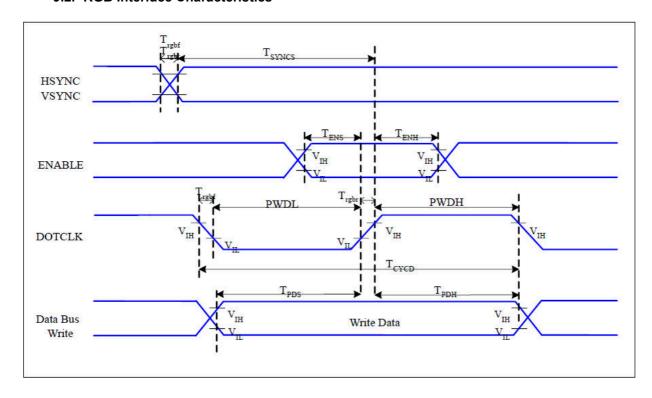
9. Timing Characteristics

9.1. Serial Interface Characteristics (3-line serial)



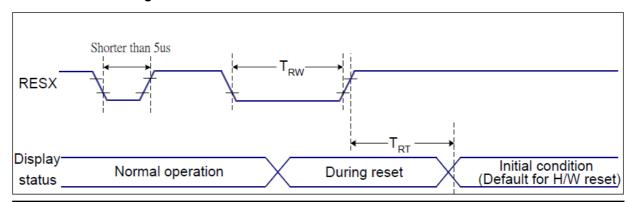
Signal	Symbol	Parameter	Min	Max	Unit	Description
	Tcss	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
CSX	Tcss	Chip select setup time (read)	60		ns	
	Tscc	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
	Tscycw	Serial clock cycle (Write)	16		ns	
	T _{SHW}	SCL "H" pulse width (Write)	7		ns	
SCL	T _{SLW}	SCL "L" pulse width (Write)	7		ns	
SCL	Tscycr	Serial clock cycle (Read)	150		ns	
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA	T _{SDS}	Data setup time	7		ns	
(DIN)	T _{SDH}	Data hold time	7		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
DOUT	Тон	Output disable time	15	50	ns	For minimum CL=8pF

9.2. RGB Interface Characteristics



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC,	+	VOVAIO LIOVAIO O L. T	30			
VSYNC	Tsyncs	VSYNC, HSYNC Setup Time		-	ns	
ENABLE	T _{ENS}	Enable Setup Time	25	-	ns	
	T _{ENH}	Enable Hold Time		-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
	PWDL	DOTCLK Low-level Pulse Width		-	ns	
	T _{CYCD}	DOTCLK Cycle Time	120	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	20	ns	
DB	T _{PDS}	PD Data Setup Time	50	-	ns	
	T _{PDH}	PD Data Hold Time	50	-	ns	

9.3. Reset timing



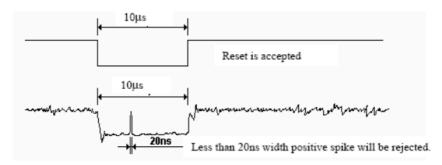
Related Pins	Symbol	Parameter	MIN	MAX	Unit
	TRW	Reset pulse duration	ration 10 -		us
RESX	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Notes:

- 1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
 - 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action		
Shorter than 5us	Reset Rejected		
Longer than 9us	Reset		
Between 5us and 9us	Reset starts		

- 3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
 - 4. Spike Rejection also applies during a valid reset pulse as shown below:



- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- 7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

10. Quality Assurance

10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2. Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5 Electrical functional: AQL 0.65.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3. Nonconforming Analysis & Disposition

- 10.3.1. Nonconforming analysis:
 - 10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.
 - 10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.
- 10.3.2. Disposition of nonconforming:
 - 10.3.2.1. Non-conforming product over PPM level will be replaced.
 - 10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

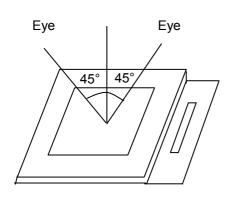
10.4. Agreement Items

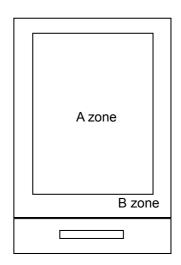
Shall negotiate with customer if the following situation occurs:

- 10.4.1. There is any discrepancy in standard of quality assurance.
- 10.4.2. Additional requirement to be added in product specification.
- 10.4.3. Any other special problem.

10.5. Standard of the Product Visual Inspection

- 10.5.1. Appearance inspection:
 - 10.5.1.1. The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.
 - 10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
 - 10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,





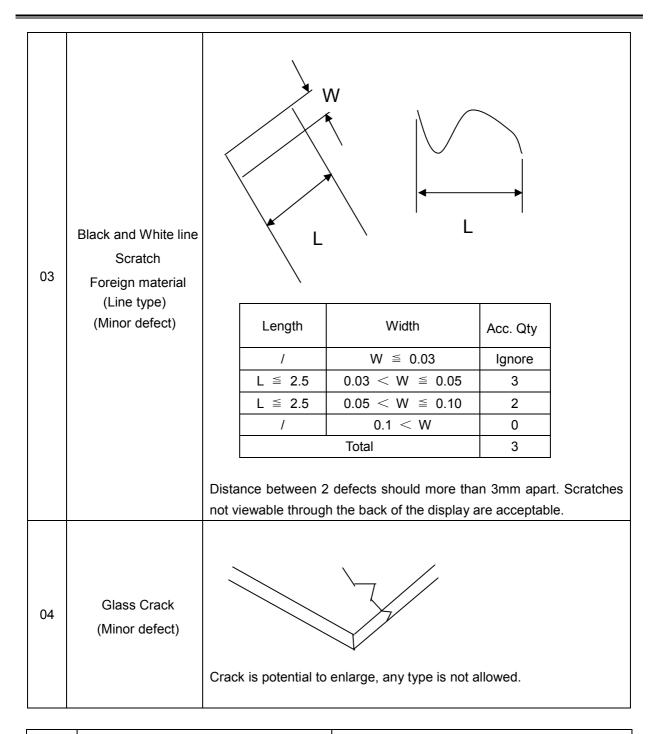
10.5.2. Basic principle:

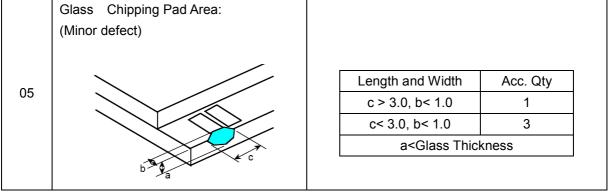
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

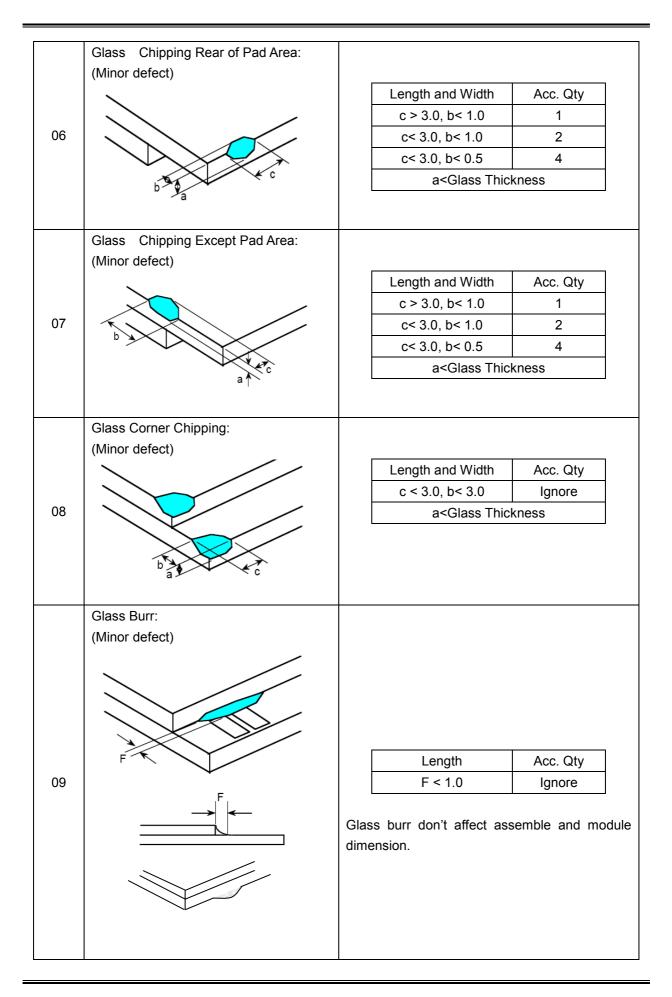
10.5.2.2. New item must be added on time when it is necessary.

10.6.Inspection Specification

No.	Item	Criteria (Unit: mm)				
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	ϕ = (a + b)/2 Distance between 2 d	Size	≤0.15 ≤0.25 <φ	φ≤ (nclude
02	Electrical Defect (Minor defect)			0 ≤2 ≤2 0 filters.	Note 1 Note 2	







10	FPC Defect: (Minor defect)	- ←	(w: circuitry width 10.2 Open circuit	10.1 Dent, pinhole width a<w 3.<="" li="">(w: circuitry width.)10.2 Open circuit is unacceptable.10.3 No oxidation, contamination and distortion.</w>		
11	Bubble on Polarizer (Minor defect)		Diameter $\phi \leqslant 0.20$ $0.20 < \phi \leqslant 0.30$ $0.30 < \phi \leqslant 0.50$ $0.50 < \phi$	Acc. Qty Ignore 4 1 None		
12	Dent on Polarizer (Minor defect)		Diameter $\phi \leqslant 0.20$ $0.20 < \phi \leqslant 0.30$ $0.30 < \phi \leqslant 0.50$ $0.50 < \phi$	Acc. Qty Ignore 4 1 None		
13	Bezel 13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination.					
14	PCB	14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F.				
15	Soldering	Follow IPC-A-610C standard				
16	Electrical Defect (Major defect)	The below defects must be rejected. 16.1 Missing vertical / horizontal segment, 16.2 Abnormal Display. 16.3 No function or no display. 16.4 Current exceeds product specifications. 16.5 LCD viewing angle defect. 16.6 No Backlight. 16.7 Dark Backlight. 16.8 Touch Panel no function.				

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7. Classification of Defects

- 10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2. Two minor defects are equal to one major in lot sampling inspection.

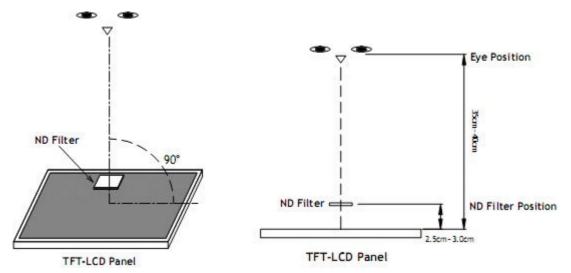
10.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

10.9. Packing

- 10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2. Modules inside package box should have compliant mark.
- 10.9.3. All direct package materials shall offer ESD protection.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity Storage 50 °C, 90%RH, 96Hrs		2	GB/T2423.3 -2016
4	High Temperature Storage 80 ℃, 96Hrs		2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test Storage	-20℃, 60min~70℃, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	-	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: \pm 4KV 150pF/330 Ω 5 times	2	GB/T17626.2 -2018
	Liectrical Static Discharge	Contact: \pm 2KV 150pF/330 Ω 5 times		
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	-	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1. Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2. Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3. Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting

Solder Pin Lead
Recommended

Solder Pin Lead
Not Recommended

12.4.2. Pins of EL

12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 ℃

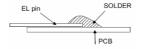
Typical Soldering Time: ≤2s

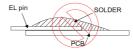
Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

12.4.2.6. Solder Wetting





Recommended

Not Recommended

12.4.2.7. The type of the solder iron:





Recommended

Not Recommended

12.4.2.8. Solder Pad



12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it may develop image sticking due to the TFT structure.

12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7. Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

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